



MICROSS COMPONENTS WILL BE EXHIBITING AT THE DMSMS 2010 CONFERENCE

**Rio Hotel & Casino, Las Vegas, NV
October 25-28, 2010
Booth 307**

The conference addresses Diminishing Material and Obsolescence issues faced by Military and Space electronics manufacturers. This four-day conference features speakers from DoD and industry senior leadership, and is organized with general sessions, technical sessions, and tutorials.

Representatives from Microcross will be on-hand to discuss the various aspects of our products and services including Custom Packaging Solutions; Turnkey Device Manufacturing (Space & Military); Device Testing / Rescreening / Upscreening; Component Lead Modification; Bare Die & Wafer Products and related services; Standard Military Memory Products.

Come visit us at Booth 307!

For more information please visit the website www.dmsms2010.com.